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# Understanding <u>Embedded - FPGAs (Field Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	4548
Number of Logic Elements/Cells	90960
Total RAM Bits	4520448
Number of I/O	650
Number of Gates	-
Voltage - Supply	1.15V ~ 1.25V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1508-BBGA, FCBGA
Supplier Device Package	1508-FBGA, FC (40x40)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep2sgx90ff1508c3

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

# 1. Introduction



SIIGX51001-1.6

The Stratix® II GX family of devices is Altera's third generation of FPGAs to combine high-speed serial transceivers with a scalable, high-performance logic array. Stratix II GX devices include 4 to 20 high-speed transceiver channels, each incorporating clock and data recovery unit (CRU) technology and embedded SERDES capability at data rates of up to 6.375 gigabits per second (Gbps). The transceivers are grouped into four-channel transceiver blocks and are designed for low power consumption and small die size. The Stratix II GX FPGA technology is built upon the Stratix II architecture and offers a 1.2-V logic array with unmatched performance, flexibility, and time-to-market capabilities. This scalable, high-performance architecture makes Stratix II GX devices ideal for high-speed backplane interface, chip-to-chip, and communications protocol-bridging applications.

# **Features**

This section lists the Stratix II GX device features.

### Main device features:

- TriMatrix memory consisting of three RAM block sizes to implement true dual-port memory and first-in first-out (FIFO) buffers with performance up to 550 MHz
- Up to 16 global clock networks with up to 32 regional clock networks per device region
- High-speed DSP blocks provide dedicated implementation of multipliers (at up to 450 MHz), multiply-accumulate functions, and finite impulse response (FIR) filters
- Up to four enhanced PLLs per device provide spread spectrum, programmable bandwidth, clock switch-over, real-time PLL reconfiguration, and advanced multiplication and phase shifting
- Support for numerous single-ended and differential I/O standards
- High-speed source-synchronous differential I/O support on up to 71 channels
- Support for source-synchronous bus standards, including SPI-4 Phase 2 (POS-PHY Level 4), SFI-4.1, XSBI, UTOPIA IV, NPSI, and CSIX-L1
- Support for high-speed external memory, including quad data rate (QDR and QDRII) SRAM, double data rate (DDR and DDR2) SDRAM, and single data rate (SDR) SDRAM



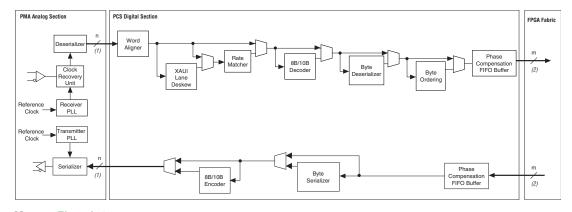
# 2. Stratix II GX Architecture

SIIGX51003-2.2

# **Transceivers**

Stratix<sup>®</sup> II GX devices incorporate dedicated embedded circuitry on the right side of the device, which contains up to 20 high-speed 6.375-Gbps serial transceiver channels. Each Stratix II GX transceiver block contains four full-duplex channels and supporting logic to transmit and receive high-speed serial data streams. The transceivers deliver bidirectional point-to-point data transmissions, with up to 51 Gbps (6.375 Gbps per channel) of full-duplex data transmission per transceiver block. Figure 2–1 shows the function blocks that make up a transceiver channel within the Stratix II GX device.

Figure 2-1. Stratix II GX Transceiver Block Diagram



### *Notes to Figure 2–1:*

- (1) n represents the number of bits in each word that need to be serialized by the transmitter portion of the PMA or have been describing by the receiver portion of the PMA. n = 8, 10, 16, or 20.
- (2) m represents the number of bits in the word that pass between the FPGA logic and the PCS portion of the transceiver. m = 8, 10, 16, 20, 32, or 40.

Transceivers within each block are independent and have their own set of dividers. Therefore, each transceiver can operate at different frequencies. Each block can select from two reference clocks to provide two clock domains that each transceiver can select from.



The Stratix II GX receivers also have adaptive equalization capability that adjusts the equalization levels to compensate for changing link characteristics. The adaptive equalization can be powered down dynamically after it selects the appropriate equalization levels.

The receiver equalization circuit is comprised of a programmable amplifier. Each stage is a peaking equalizer with a different center frequency and programmable gain. This allows varying amounts of gain to be applied, depending on the overall frequency response of the channel loss. Channel loss is defined as the summation of all losses through the PCB traces, vias, connectors, and cables present in the physical link. Figure 2–15 shows the frequency response for the 16 programmable settings allowed by the Quartus II software for Stratix II GX devices.

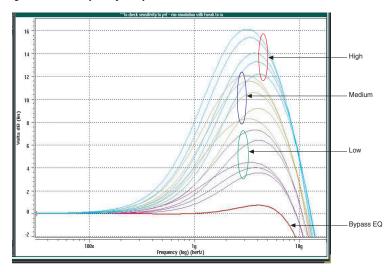


Figure 2-15. Frequency Response

### Receiver PLL and CRU

Each transceiver block has four receiver PLLs, lock detectors, signal detectors, run length checkers, and CRU units, each of which is dedicated to a receive channel. If the receive channel associated with a particular receiver PLL or CRU is not used, the receiver PLL and CRU are powered down for the channel. Figure 2–16 shows the receiver PLL and CRU circuits.

Table 2–11 summarizes the possible clocking connections for the transceivers.

Table 2–11. Availa	Table 2–11. Available Clocking Connections for Transceivers											
	Destination											
Source	Transmitter PLL	Receiver PLL	Global Clock	Regional Clock	Inter-Transceiver Lines							
REFCLK[10]	<b>✓</b>	<b>✓</b>	<b>✓</b>	<b>✓</b>	<b>✓</b>							
Transmitter PLL			✓	<b>✓</b>								
Receiver PLL			✓	<b>✓</b>								
Global clock (driven from an input pin)	<b>✓</b>	~										
Inter-transceiver lines	<b>✓</b>	~										

### Clock Resource for PLD-Transceiver Interface

For the regional or global clock network to route into the transceiver, a local route input output (LRIO) channel is required. Each LRIO clock region has up to eight clock paths and each transceiver block has a maximum of eight clock paths for connecting with LRIO clocks. These resources are limited and determine the number of clocks that can be used between the PLD and transceiver blocks. Table 2–12 shows the number of LRIO resources available for Stratix II GX devices with different numbers of transceiver blocks.

Tables 2–12 through 2–15 show the connection of the LRIO clock resource to the transceiver block.

Table 2–12. Av	ailable Clocki	ing Connection	s for Transcei	vers in 2SGX30D		
	Clock R	Transceiver				
Region	Global Clock	Regional Clock	Bank 13 8 Clock I/O	Bank 14 8 Clock I/O		
Region0 8 LRIO clock	✓	RCLK 20-27	✓			
Region1 8 LRIO clock	✓	RCLK 12-19		<b>✓</b>		

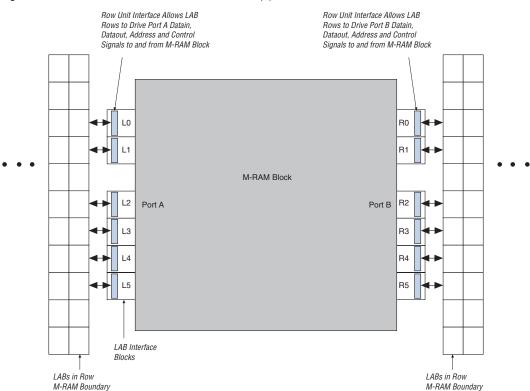


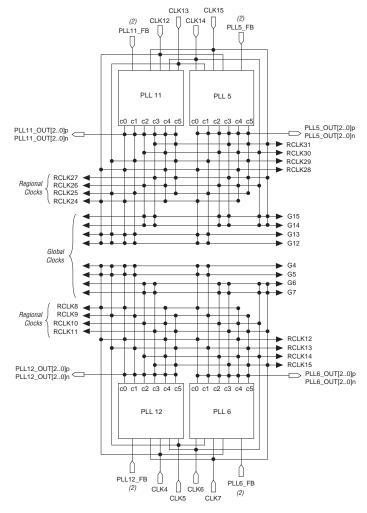
Figure 2–55. M-RAM Block LAB Row Interface Note (1)

*Note to Figure 2–55:* 

(1) Only R24 and C16 interconnects cross the M-RAM block boundaries.

Figure 2–73 shows the global and regional clocking from enhanced PLL outputs and top and bottom CLK pins.

Figure 2–73. Global and Regional Clock Connections from Top and Bottom Clock Pins and Enhanced PLL Outputs Notes (1), (2)



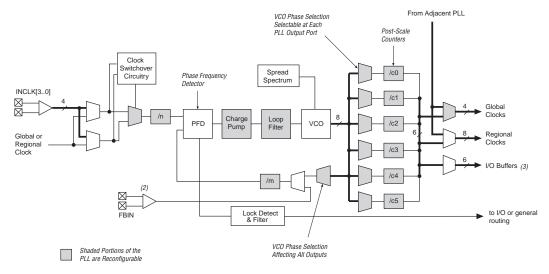
### *Notes to Figure 2–73:*

- (1) EP2SGX30C/D and EP2SGX60C/D devices only have two enhanced PLLs (5 and 6), but the connectivity from these two PLLs to the global and regional clock networks remains the same as shown.
- (2) If the design uses the feedback input, you will lose one (or two, if FBIN is differential) external clock output pin.

### **Enhanced PLLs**

Stratix II GX devices contain up to four enhanced PLLs with advanced clock management features. These features include support for external clock feedback mode, spread-spectrum clocking, and counter cascading. Figure 2–74 shows a diagram of the enhanced PLL.

Figure 2–74. Stratix II GX Enhanced PLL Note (1)



### *Notes to Figure 2–74:*

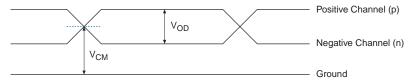
- Each clock source can come from any of the four clock pins that are physically located on the same side of the device
  as the PLL.
- (2) If the feedback input is used, you will lose one (or two, if FBIN is differential) external clock output pin.
- (3) Each enhanced PLL has three differential external clock outputs or six single-ended external clock outputs.
- (4) The global or regional clock input can be driven by an output from another PLL, a pin-driven dedicated global or regional clock, or through a clock control block provided the clock control block is fed by an output from another PLL or a pin-driven dedicated global or regional clock. An internally generated global signal cannot drive the PLL.

### **Fast PLLs**

Stratix II GX devices contain up to four fast PLLs with high-speed serial interfacing ability. The fast PLLs offer high-speed outputs to manage the high-speed differential I/O interfaces. Figure 2–75 shows a diagram of the fast PLL.

Figure 4-4. Transmitter Output Waveform

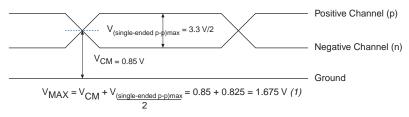




# Differential Waveform $V_{OD}$ (diff peak-peak) = 2 x $V_{OD}$ (single-ended) $V_{OD}$ p-n=0 $V_{OD}$

Figure 4-5. Maximum Receiver Input Pin Voltage

### Single-Ended Waveform



*Note to Figure 4–5:* 

(1) The absolute  $V_{MAX}$  that the receiver input pins can tolerate is 2 V.

Tables 4–7 through 4–12 show the typical  $V_{OD}$  for data rates from 600 Mbps to 6.375 Gbps. The specification is for measurement at the package ball.

Table 4–7. Typical	Table 4–7. Typical $V_{OD}$ Setting, TX Term = 100 $\Omega$ Note (1)											
V <sub>CCH</sub> TX = 1.5 V V <sub>OD</sub> Setting (mV)												
	200	200 400 600 800 1000 1200 1400										
V <sub>OD</sub> Typical (mV)	220	430	625	830	1020	1200	1350					

Note to Table 4-7:

(1) Applicable to data rates from 600 Mbps to 6.375 Gbps. Specification is for measurement at the package ball.

Table 4–19. Strati	ix II GX Transceiver Bi	lock AC	Specif	ication	Notes (	(1), (2)	, (3) <b>(P</b>	art 9 o	f 19)		
Symbol/ Description	Conditions	-3 Speed Commercial Speed Grade			-4 Speed Commercial and Industrial Speed Grade			-5 Speed Commercial Speed Grade			Unit
		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
HiGig Receiver Jit	ter Tolerance (13)										
Deterministic Jitter Tolerance (peak-to-peak)	Data Rate = 3.75 Gbps REFCLK = 187.5 MHz Pattern = CJPAT No Equalization DC Gain = 3 dB		> 0.37	,		-			-		U
Combined	Data Rate = 3.75 Gbps REFCLK = 187.5 MHz Pattern = CJPAT No Equalization DC Gain = 3 dB		> 0.65	,		-			-		UI
Deterministic and Random Jitter Tolerance (peak-to-peak)	Jitter Frequency = 22.1 KHz Data Rate = 3.75 Gbps REFCLK = 187.5 MHz Pattern = CJPAT No Equalization DC Gain = 3 dB		> 8.5			-			-		UI

Symbol/ Description	Conditions	-3 Speed Commercial Speed Grade			-4 Speed Commercial and Industrial Speed Grade			-5 Speed Commercial Speed Grade			Unit
		Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
Sinusoidal Jitter Tolerance (peak-to-peak) <i>(6)</i> (cont.)	Jitter Frequency = 20 MHz Data Rate = 614.4 Mbps, 1.2288 Gbps, 2.4576 Gbps REFCLK = 61.44 MHz for 614.4 Mbps REFCLK = 122.88 MHz for 1.2288 Gbps and 2.4576 Gbps Pattern = CJPAT Equalizer Setting = 6 DC Gain = 0 dB		> 0.1			> 0.1			N/A		UI

# **Bus Hold Specifications**

Table 4–48 shows the Stratix II GX device family bus hold specifications.

Table 4-48.	. Bus Hold Para	meters										
			V <sub>CCIO</sub> Level									
Parameter	Conditions	1.2	2 V	1.	.5 V	1.8	8 V	2.	5 V	3.3	3 V	Unit
		Min	Max	Min	Max	Min	Max	Min	Max	Min	Max	
Low sustaining current	V <sub>IN</sub> > V <sub>IL</sub> (maximum)	22.5		25		30		50		70		μΑ
High sustaining current	V <sub>IN</sub> < V <sub>IH</sub> (minimum)	-22.5		-25		-30		-50		-70		μΑ
Low overdrive current	0 V < V <sub>IN</sub> < V <sub>CCIO</sub>		120		160		200		300		500	μА
High overdrive current	0 V < V <sub>IN</sub> < V <sub>CCIO</sub>		-120		-160		-200		-300		-500	μА
Bus-hold trip point		0.45	0.95	0.5	1.0	0.68	1.07	0.7	1.7	0.8	2.0	٧

# **On-Chip Termination Specifications**

Tables 4–49 and 4–50 define the specification for internal termination resistance tolerance when using series or differential on-chip termination.

Table 4-4	49. On-Chip Termination Specificat	ion for Top and Bottor	m I/O Banks (Par	t 1 of 2) Notes	s (1) <b>,</b> (2)
			Resist	ance Tolerance	
Symbol	Description	Conditions	Commercial Max	Industrial Max	Unit
25-Ω R <sub>S</sub> 3.3/2.5	Internal series termination with calibration (25- $\Omega$ setting)	$V_{CCIO} = 3.3/2.5 \text{ V}$	±5	±10	%
	Internal series termination without calibration (25- $\Omega$ setting)	V <sub>CCIO</sub> = 3.3/2.5 V	±30	±30	%
50-ΩR <sub>S</sub> 3.3/2.5	Internal series termination with calibration (50-Ω setting)	V <sub>CCIO</sub> = 3.3/2.5 V	±5	±10	%
	Internal series termination without calibration (50- $\Omega$ setting)	V <sub>CCIO</sub> = 3.3/2.5 V	±30	± 30	%

Table 4-57. IC	DE Internal Timing Micro	parame	ters (Pa	rt 2 of 2	<u>')</u>					
Symbol	Parameter	-3 Speed Grade (1)		-3 Speed Grade (2)		-4 Speed Grade		-5 Speed Grade		Unit
,		Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>PIN2COMBOUT_R</sub>	Row input pin to IOE combinational output	410	760	410	798	410	848	410	1018	ps
t <sub>PIN2COMBOUT_C</sub>	Column input pin to IOE combinational output	428	787	428	825	428	878	428	1054	ps
t <sub>COMBIN2PIN_R</sub>	Row IOE data input to combinational output pin	1101	2026	1101	2127	1101	2261	1101	2439	ps
t <sub>COMBIN2PIN_C</sub>	Column IOE data input to combinational output pin	991	1854	991	1946	991	2069	991	2246	ps
t <sub>CLR</sub>	Minimum clear pulse width	200		210		223		268		ps
t <sub>PRE</sub>	Minimum preset pulse width	200		210		223		268		ps
t <sub>CLKL</sub>	Minimum clock low time	600		630		669		804		ps
t <sub>CLKH</sub>	Minimum clock high time	600		630		669		804		ps

 <sup>(1)</sup> This column refers to -3 speed grades for EP2SGX30, EP2SGX60, and EP2SGX90 devices.
 (2) This column refers to -3 speed grades for EP2SGX130 devices.

Symbol	Parameter	-3 Speed Grade (1)		-3 Speed Grade <i>(2)</i>		-4 Speed Grade		-5 Speed Grade		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
t <sub>SU</sub>	Input, pipeline, and output register setup time before clock	50		52		55		67		ps
t <sub>H</sub>	Input, pipeline, and output register hold time after clock	180		189		200		241		ps
t <sub>CO</sub>	Input, pipeline, and output register clock-to-output delay	0	0	0	0	0	0	0	0	ps

Table 4-77. E	Table 4–77. EP2SGX130 Column Pins Regional Clock Timing Parameters											
Parameter	Fast	Corner	-3 Speed	-4 Speed	-5 Speed	Units						
Parameter	Industrial	Commercial	Grade	Grade	Grade	UIIIIS						
t <sub>CIN</sub>	1.815	1.834	3.218	3.417	4.087	ns						
t <sub>COUT</sub>	1.650	1.669	3.218	3.417	4.087	ns						
t <sub>PLLCIN</sub>	0.116	0.134	0.349	0.364	0.426	ns						
t <sub>PLLCOUT</sub>	-0.049	-0.031	0.361	0.378	0.444	ns						

Table 4–78. E	Table 4–78. EP2SGX130 Row Pins Regional Clock Timing Parameters											
Parameter	Fast (	Corner	-3 Speed	-4 Speed	-5 Speed	Units						
raiailletei	Industrial	Commercial	Grade	Grade	Grade	UIIIIS						
t <sub>CIN</sub>	1.544	1.560	3.195	3.395	4.060	ns						
t <sub>COUT</sub>	1.549	1.565	3.195	3.395	4.060	ns						
t <sub>PLLCIN</sub>	-0.149	-0.132	0.34	0.356	0.417	ns						
t <sub>PLLCOUT</sub>	-0.144	-0.127	0.342	0.356	0.417	ns						

# **Clock Network Skew Adders**

The Quartus II software models skew within dedicated clock networks such as global and regional clocks. Therefore, the intra-clock network skew adder is not specified. Table 4–79 specifies the intra-clock skew between any two clock networks driving any registers in the Stratix II GX device.

Table 4–79. Clock Network Specifications (Part 1 of 2)						
Name	Description	Min	Тур	Max	Unit	
Clock skew adder	Inter-clock network, same side			±50	ps	
EP2SGX30 (1)	Inter-clock network, entire chip			±100	ps	
Clock skew adder	Inter-clock network, same side			±50	ps	
EP2SGX60 (1)	Inter-clock network, entire chip			±100	ps	
Clock skew adder	Inter-clock network, same side			±55	ps	
EP2SGX90 (1)	Inter-clock network, entire chip			±110	ps	

Table 4–82. Default Loading of Different I/O Standards for Stratix II GX Devices (Part 2 of 2)

I/O Standard	Capacitive Load	Unit
SSTL-18 Class I	0	pF
SSTL-18 Class II	0	pF
1.5-V HSTL Class I	0	pF
1.5-V HSTL Class II	0	pF
1.8-V HSTL Class I	0	pF
1.8-V HSTL Class II	0	pF
Differential SSTL-2 Class I	0	pF
Differential SSTL-2 Class II	0	pF
Differential SSTL-18 Class I	0	pF
Differential SSTL-18 Class II	0	pF
1.5-V differential HSTL Class I	0	pF
1.5-V differential HSTL Class II	0	pF
1.8-V differential HSTL Class I	0	pF
1.8-V differential HSTL Class II	0	pF
LVDS	0	pF

# I/O Delays

See Tables 4–83 through 4–87 for I/O delays.

Table 4–83. I/O Delay Parameters				
Symbol	Parameter			
t <sub>DIP</sub>	Delay from I/O datain to output pad			
t <sub>OP</sub>	Delay from I/O output register to output pad			
t <sub>PCOUT</sub>	Delay from input pad to I/O dataout to core			
t <sub>Pl</sub>	Delay from input pad to I/O input register			

Table 4–84. Stratix II GX I/O Input Delay for Column Pins (Part 1 of 3)							
I/O Standard	Parameter	Fast Corner Industrial/ Commercial	-3 Speed Grade (2)	-3 Speed Grade (3)	-4 Speed Grade	-5 Speed Grade	Unit
LVTTL	t <sub>Pl</sub>	707	1223	1282	1364	1637	ps
	t <sub>PCOUT</sub>	428	787	825	878	1054	ps

I/O Standard	Drive Strength	Parameter	Fast Corner Industrial/ Commercial	-3 Speed Grade (3)	-3 Speed Grade (4)	-4 Speed Grade	-5 Speed Grade	Unit
2.5 V	4 mA	t <sub>OP</sub>	1053	2063	2165	2302	2480	ps
		t <sub>DIP</sub>	1075	2129	2235	2376	2570	ps
	8 mA	t <sub>OP</sub>	1001	1841	1932	2054	2218	ps
		t <sub>DIP</sub>	1023	1907	2002	2128	2308	ps
	12 mA	t <sub>OP</sub>	980	1742	1828	1944	2101	ps
		t <sub>DIP</sub>	1002	1808	1898	2018	2191	ps
	16 mA (1)	t <sub>OP</sub>	962	1679	1762	1873	2027	ps
		t <sub>DIP</sub>	984	1745	1832	1947	2117	ps
1.8 V	2 mA	t <sub>OP</sub>	1093	2904	3048	3241	3472	ps
		t <sub>DIP</sub>	1115	2970	3118	3315	3562	ps
	4 mA	t <sub>OP</sub>	1098	2248	2359	2509	2698	ps
		t <sub>DIP</sub>	1120	2314	2429	2583	2788	ps
	6 mA	t <sub>OP</sub>	1022	2024	2124	2258	2434	ps
		t <sub>DIP</sub>	1044	2090	2194	2332	2524	ps
	8 mA	t <sub>OP</sub>	1024	1947	2043	2172	2343	ps
		t <sub>DIP</sub>	1046	2013	2113	2246	2433	ps
	10 mA	t <sub>OP</sub>	978	1882	1975	2100	2266	ps
		t <sub>DIP</sub>	1000	1948	2045	2174	2356	ps
	12 mA (1)	t <sub>OP</sub>	979	1833	1923	2045	2209	ps
		t <sub>DIP</sub>	1001	1899	1993	2119	2299	ps
1.5 V	2 mA	t <sub>OP</sub>	1073	2505	2629	2795	3002	ps
		t <sub>DIP</sub>	1095	2571	2699	2869	3092	ps
	4 mA	t <sub>OP</sub>	1009	2023	2123	2257	2433	ps
		t <sub>DIP</sub>	1031	2089	2193	2331	2523	ps
	6 mA	t <sub>OP</sub>	1012	1923	2018	2146	2315	ps
		t <sub>DIP</sub>	1034	1989	2088	2220	2405	ps
	8 mA (1)	t <sub>OP</sub>	971	1878	1970	2095	2262	ps
		t <sub>DIP</sub>	993	1944	2040	2169	2352	ps

Table 4–90. Stratix II GX Maximum Input Clock Rate for Dedicated Clock Pins (Part 2 of 2)					
I/O Standard	-3 Speed Grade	-4 Speed Grade	-5 Speed Grade	Unit	
1.8-V HSTL CLass I	500	500	500	MHz	
PCI	500	500	400	MHz	
PCI-X	500	500	400	MHz	
Differential SSTL-2 Class I	500	500	500	MHz	
Differential SSTL-2 Class II	500	500	500	MHz	
Differential SSTL-18 Class I	500	500	500	MHz	
Differential SSTL-18 Class II	500	500	500	MHz	
1.8-V differential HSTL Class I	500	500	500	MHz	
1.8-V differential HSTL Class II	500	500	500	MHz	
1.5-V differential HSTL Class I	500	500	500	MHz	
1.5-V differential HSTL Class I I	500	500	500	MHz	
HyperTransport (1)	717	717	640	MHz	
	450	450	400	MHz	
LVPECL (1), (2)	717	717	640	MHz	
Ī	450	450	400	MHz	
LVDS (1)	717	717	640	MHz	
Ī	450	450	400	MHz	

 $<sup>(1) \</sup>quad \text{The first set of numbers refers to the HIO dedicated clock pins. The second set of numbers refers to the VIO}$ dedicated clock pins.
(2) LVPECL is only supported on column clock pins.

Table 4–91. Stratix II GX Maximum Output Clock Rate for Column Pins (Part 2 of 3)						
I/O Standard	Drive Strength	-3 Speed Grade	-4 Speed Grade	-5 Speed Grade	Unit	
SSTL-18 Class I	4 mA	200	150	150	MHz	
	6 mA	350	250	200	MHz	
	8 mA	450	300	300	MHz	
	10 mA	500	400	400	MHz	
	12 mA (1)	700	550	400	MHz	
SSTL-18 Class II	8 mA	200	200	150	MHz	
	16 mA	400	350	350	MHz	
	18 mA	450	400	400	MHz	
	20 mA (1)	550	500	450	MHz	
1.8-V HSTL	4 mA	300	300	300	MHz	
Class I	6 mA	500	450	450	MHz	
	8 mA	650	600	600	MHz	
	10 mA	700	650	600	MHz	
	12 mA (1)	700	700	650	MHz	
1.8-V HSTL	16 mA	500	500	450	MHz	
Class II	18 mA	550	500	500	MHz	
	20 mA (1)	650	550	550	MHz	
1.5-V HSTL	4 mA	350	300	300	MHz	
Class I	6 mA	500	500	450	MHz	
	8 mA	700	650	600	MHz	
	10 mA	700	700	650	MHz	
	12 mA (1)	700	700	700	MHz	
1.5-V HSTL	16 mA	600	600	550	MHz	
Class II	18 mA	650	600	600	MHz	
	20 mA (1)	700	650	600	MHz	
PCI	-	1000	790	670	MHz	
PCI-X	-	1000	790	670	MHz	
Differential	8 mA	400	300	300	MHz	
SSTL-2 Class I	12 mA	400	400	350	MHz	
Differential	16 mA	350	350	300	MHz	
SSTL-2 Class II	20 mA	400	350	350	MHz	
	24 mA	400	400	350	MHz	

I/O Standard	<b>Drive Strength</b>	-3 Speed Grade	-4 Speed Grade	-5 Speed Grade	Unit
Differential	8 mA	400	300	300	MHz
SSTL-2 Class I	12 mA	400	400	350	MHz
Differential SSTL-2 Class II	16 mA (1)	350	350	300	MHz
Differential	4 mA	200	150	150	MHz
SSTL-18 Class I	6 mA	350	250	200	MHz
	8 mA	450	300	300	MHz
	10 mA (1)	500	400	400	MHz
LVDS	-	717	717	640	MHz
HyperTransport	-	717	717	640	MHz

<sup>(1)</sup> This is the default setting in Quartus II software.

Table 4–93 shows the maximum output clock toggle rate for Stratix II GX device dedicated clock pins.

Table 4–93. Stratix II GX Maximum Output Clock Rate for Dedicated Clock Pins (Part 1 of 4)					
I/O Standard	Drive Strength	-3 Speed Grade	-4 Speed Grade	-5 Speed Grade	Unit
LVTTL	4 mA	270	225	210	MHz
	8 mA	435	355	325	MHz
	12 mA	580	475	420	MHz
	16 mA	720	594	520	MHz
	20 mA	875	700	610	MHz
	24 mA (1)	1030	794	670	MHz
LVCMOS	4 mA	290	250	230	MHz
	8 mA	565	480	440	MHz
	12 mA	790	710	670	MHz
	16 mA	1020	925	875	MHz
	20 mA	1066	985	935	MHz
	24 mA (1)	1100	1040	1000	MHz

Tables 4–98 through 4–105 show the maximum DCD in absolution derivation for different I/O standards on Stratix II GX devices. Examples are also provided that show how to calculate DCD as a percentage.

Table 4–98. Maximum DCD for Non-DDIO Output on Row I/O Pins					
Day I/O Output Standard	Maximum DCD (ps) for Non-DDIO Output				
Row I/O Output Standard	-3 Devices	-4 and -5 Devices	Unit		
3.3-V LVTTTL	245	275	ps		
3.3-V LVCMOS	125	155	ps		
2.5 V	105	135	ps		
1.8 V	180	180	ps		
1.5-V LVCMOS	165	195	ps		
SSTL-2 Class I	115	145	ps		
SSTL-2 Class II	95	125	ps		
SSTL-18 Class I	55	85	ps		
1.8-V HSTL Class I	80	100	ps		
1.5-V HSTL Class I	85	115	ps		
LVDS	55	80	ps		

Here is an example for calculating the DCD as a percentage for a non-DDIO output on a row I/O on a -3 device:

If the non-DDIO output I/O standard is SSTL-2 Class II, the maximum DCD is 95 ps (see Table 4–99). If the clock frequency is 267 MHz, the clock period T is:

$$T = 1/f = 1/267 \text{ MHz} = 3.745 \text{ ns} = 3,745 \text{ ps}$$

To calculate the DCD as a percentage:

$$(T/2 - DCD) / T = (3,745 ps/2 - 95 ps) / 3,745 ps = 47.5\%$$
 (for low boundary)

$$(T/2 + DCD) / T = (3,745 ps/2 + 95 ps) / 3,745 ps = 52.5\%$$
 (for high boundary)

Table 4–104. Maximum DCD for DDIO Output on Row I/O Pins With PLL in the Clock Path

Maximum DCD (ps) for Row DDIO Output I/O	Stratix II GX Devices (PLL Output Feeding DDIO)		
Standard	-3 Device	-4 and -5 Device	
3.3-V LVTTL	110	105	ps
3.3-V LVCMOS	65	75	ps
2.5V	75	90	ps
1.8V	85	100	ps
1.5-V LVCMOS	105	100	ps
SSTL-2 Class I	65	75	ps
SSTL-2 Class II	60	70	ps
SSTL-18 Class I	50	65	ps
1.8-V HSTL Class I	50	70	ps
1.5-V HSTL Class I	55	70	ps
LVDS	180	180	ps

Table 4–105. Maximum DCD for DDIO Output on Column I/O Pins With PLL in the Clock Path  $\,$  (Part 1 of 2)

Maximum DCD (ps) for Column DDIO Output I/O	Stratix II GX Devices (PLL Output Feeding DDIO)			
Standard	-3 Device	-4 and -5 Device		
3.3-V LVTTL	145	160	ps	
3.3-V LVCMOS	100	110	ps	
2.5V	85	95	ps	
1.8V	85	100	ps	
1.5-V LVCMOS	140	155	ps	
SSTL-2 Class I	65	75	ps	
SSTL-2 Class II	60	70	ps	
SSTL-18 Class I	50	65	ps	
SSTL-18 Class II	70	80	ps	
1.8-V HSTL Class I	60	70	ps	
1.8-V HSTL Class II	60	70	ps	
1.5-V HSTL Class I	55	70	ps	
1.5-V HSTL Class II	85	100	ps	